National Semiconductor

MICROCIRCUIT DATA SHEET

MNLP2951-X REV 1B1

Original Creation Date: 08/01/95
Last Update Date: 05/19/98
Last Major Revision Date: 11/11/96

ADJUSTABLE MICROPOWER VOLTAGE REGULATORS

General Description

The LP2951 is a micropower voltage regulator with very low dropout voltage (typ. 40 mV at light loads and 380 mV at 100 mA). It is ideally suited for use in battery-powered systems. Furthermore, the quiescent current of the LP2951 increases only slightly in dropout, prolonging battery life.

An attractive feature is an error flag output which warns of a low output voltage, often due to falling battery voltage on the input. It may be used for a power-on reset. A second feature is the logic-compatible shutdown input which enables the regulator to be switched on and off. Also, the part may be pin-strapped for a 5V output or programmed from 1.24V to 29V with an external pair of resistors.

Careful design of the LP2951 has minimized all contributions to the error budget. This includes a tight initial tolerance(0.5% typ.), extremely good load and line regulation (0.05% typ.) and a very low output voltage temperature coefficient, making the part useful as a low-power voltage reference.

Industry Part Number

LP2951

Prime Die

LP2951

Controlling Document

See Features Page

NS Part Numbers

LP2951E/883*
LP2951H/883**
LP2951J/883***
LP2951WG/883****

Processing

MIL-STD-883, Method 5004

Quality Conformance Inspection

MIL-STD-883, Method 5005

Subgrp	Description	Temp (^{O}C)
1	Static tests at	+25
2	Static tests at	+125
3	Static tests at	-55
4	Dynamic tests at	+25
5	Dynamic tests at	+125
6	Dynamic tests at	-55
7	Functional tests at	+25
8A	Functional tests at	+125
8B	Functional tests at	-55
9	Switching tests at	+25
10	Switching tests at	+125
11	Switching tests at	-55

Features

- Error flag warns of output dropout.
- Logic-controlled electronic shutdown.
- Output programmable from 1.24 to 29V.
- SMD : 5962-38705M2A*, MGA**, MPA***, MXA****

(Absolute Maximum Ratings)

(Note 1)

Power Dissipation		
METAL CAN		675mW at +25 C
CERDIP		1.0W at +25 C
LCC		1.25W at +25 C
CERAMIC SOIC		1.0W at +25 C
Storage Temperature Range		-65 C to +150 C
Operating Ambient Temperature Range		-55 C to +125 C
Absolute Maximum Junction Temperature		+160 C
Input Supply Voltage		-0.3 to +30V
Feedback Input Voltage (Note 3, 4)		-1.5 to +30V
Shutdown Input Voltage (Note 3)		-0.3 to +30V
Error Comparator Out. Voltage (Note 3)		-0.3 to +30V
Lead Temperature		
(Soldering, 10 seconds)		260 C
Thermal Resistance		
ThetaJA		
METAL CAN	(Still Air @ 0.5W)	163 C/W
	(500LF/Min Air flow @ 0.5W)	95 C/W
CERDIP	(Still Air @ 0.5W)	131 C/W
	(500LF/Min Air flow @ 0.5W)	75 C/W
LCC	(Still Air @ 0.5W)	95 C/W
	(500LF/Min Air flow @ 0.5W)	66 C/W
CERAMIC SOIC	(Still Air @ 0.5W)	215 C/W
	(500LF/Min Air flow @ 0.5W)	130 C/W
ThetaJC		
METAL CAN		51 C/W
CERDIP		21 C/W
LCC		24 C/W
CERAMIC SOIC		24 C/W
Package Weight		
(Typical)		TBD
ESD Rating		500V

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

Note 2: The maximum power dissipation must be derated at elevated temperatures and is dictated by Tjmax (maximum junction temperature), ThetaJA (package junction to ambient thermal resistance), and TA (ambient temperature). The maximum allowable power dissipation at any temperature is Pdmax = (Tjmax - TA)/ThetaJA or the number given in the Absolute Maximum Ratings, whichever is lower.

Note 3: May exceed input supply voltage.

Note 4: When used in dual-supply systems where the output terminal uses loads returned to a negative supply, the output voltage should be diode-clamped to ground.

Electrical Characteristics

DC PARAMETERS

(The following conditions apply to all the following parameters, unless otherwise specified.)
DC: Vin = 6V, Il = 100uA, Cl = 1uF, Vout = 5V, Vshutdown = ≤ 0.8V

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN-NAME	MIN	MAX	UNIT	SUB-GROUPS
	Output Voltage				4.975	5.025	V	1
					4.94	5.06	V	2, 3
	Line Regulation	6V ≤ Vin ≤ 30V			-5	5	mV	1
		Il = 1mA			-25	25	mV	2, 3
	Load Regulation	100uA ≤ Il ≤ 100mA			-5	5	mV	1
		100uA ≤ Il ≤ 100mA			-25	25	mV	2, 3
	Dropout Voltage	Il = 100mA	1, 2			450	mV	1
			1, 2			600	mV	2, 3
			1, 2			80	mV	1
			1, 2			150	mV	2, 3
	Ground Current	Vout = 15V, Il = 100mA			0	15	mA	1
					0	20	mA	2, 3
		Il = 100mA			0	12	mA	1
					0	14	mA	2, 3
		Vin = 6-30V			0	30	uA	1
					0	50	uA	2, 3
	Quiescent Ground Current				0	120	uA	1
					0	140	uA	2, 3
		Il = 10uA, Vout = 15V			0	120	uA	1
					0	140	uA	2, 3
	Dropout Ground Current	Vin = 4.5V			0	170	uA	1
					0	200	uA	2, 3
	Comparator Lower Threshold		1, 3			95	mV	1
			1, 3			140	mV	2, 3
	Comparator Upper Threshold		1, 3		40		mV	1
			1, 3		25		mV	2, 3
	Thermal Regulation	Vin = 30V, Il = 50mA, T = 2mS			-12.5	12.5	mV	1
		Vin = 30V, Il = 50mA, T = 10mS			-12.5	12.5	mV	1
	ISC Current Limit	Vout = 0V			0	200	mA	1
					0	220	mA	2, 3

Electrical Characteristics

DC PARAMETERS(Continued)

(The following conditions apply to all the following parameters, unless otherwise specified.)
DC: Vin = 6V, Il = 100uA, Cl = 1uF, Vout = 5V, Vshutdown = ≤ 0.8V

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN-NAME	MIN	MAX	UNIT	SUB-GROUPS
	Reference Voltage				1.22	1.25	V	1
					1.20	1.26	V	2, 3
	Reference Line Regulation	2.3V ≤ Vin ≤ 30V			-1.9	1.9	mV	1
		2.3V ≤ Vin ≤ 30V			-10	10	mV	2, 3
	Reference Output Regulation	Vref ≤ Vout ≤ (Vin-1V), Vin = 30V			-1.2	1.2	mV	1
		Vref ≤ Vout ≤ (Vin-1V), Vin = 30V			-5	5	mV	2, 3
	Feedback Bias Current				-40	40	nA	1
					-60	60	nA	2, 3
	Comparator Off Leakage	Vo = 30V			-1	1	uA	1
					-2	2	uA	2, 3
	Comparator Output Low Voltage	Vin = 4.5V, Iol = 400uA			0	250	mV	1
					0	400	mV	2, 3
	Shutdown Input Current	Vshutdown = 2.4V			0	50	uA	1
					0	100	uA	2, 3
		Vshutdown = 30V			0	600	uA	1
					0	750	uA	2, 3
	Output Leakage Current in Shutdown	Vshutdown = 1.5V, Vin = 30V			-10	10	uA	1
					-20	20	uA	2, 3
	Shutdown Input Logic Voltage	(LOW)	1			0.6	V	1, 2, 3
		(HIGH)	1		2		V	1, 2, 3

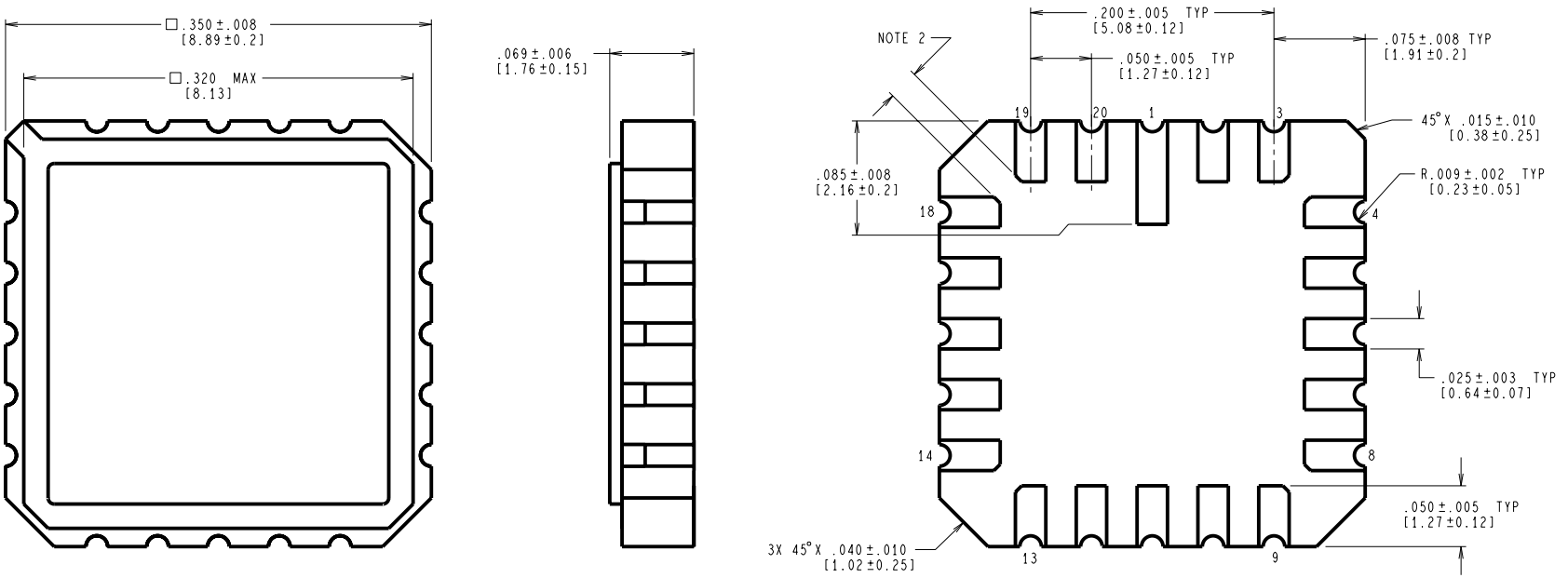
Note 1: Functional test only.
Note 2: Dropout voltage is defined as the input to output differential at which the output drops 100mV below its nominal values measured at 1V differential. At very low values of programmed output voltage, the minimum input supply voltage of 2V (2.3V over temperature) must be taken into account.
Note 3: Comparator thresholds are expressed in terms of a voltage differential at the Feedback terminal below the nominal reference voltage measured at Vin = 6V. To express these thresholds in terms of output voltage change, multiply by the error amplifer Gain=Vout/Vin=(R1 + R2)R2. For example, at a programmed output voltage of 5V, the error output is guaranteed to go low when the output drops by 95mV X 5V/1.235V = 384mV. Thresholds remain constant as a percent of Vout as Vout is varied, with the dropout warning occuring at typically 5% below nominal, 7.5% guaranteed.

Graphics and Diagrams

GRAPHICS#	DESCRIPTION
05810HRA2	METAL CAN (H), TO-99, 8LD, .200 DIA P.C. (B/I CKT)
06059HRA2	CERDIP (J), 8 LEAD (B/I CKT)
06146HRA2	LCC (E), TYPE C, 20 TERMINAL(B/I CKT)
06341HRA1	CERPACK (W), 10 LEAD (B/I CKT)
E20ARE	LCC (E), TYPE C, 20 TERMINAL(P/P DWG)
H08CRF	METAL CAN (H), TO-99, 8LD, .200 DIA P.C. (P/P DWG)
J08ARL	CERDIP (J), 8 LEAD (P/P DWG)
P000205A	METAL CAN (H), 8 LEAD (PINOUT)
P000206A	CERDIP (J), 8 LEAD (PINOUT)
P000251B	LCC (E), 20 LEAD (PINOUT)
P000374A	CERAMIC SOIC (WG), 10 LEAD (PINOUT)
WG10ARC	CERAMIC SOIC (WG), 10 LEAD (P/P DWG)

See attached graphics following this page.

REVISIONS				
LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
E	REVISE AND REDRAW.	10005	02/10/94	DEG/



NOTES: UNLESS OTHERWISE SPECIFIED.

1. LEAD FINISH TO BE ONE OF THE FOLLOWING:

   a. 50 MICROINCHES/12.7 MICROMETERS MINIMUM GOLD PLATING OVER 50-350 MICROINCHES/1.27-8.89 MICROMETERS NICKEL.

   b. SOLDER DIP.
   SOLDER THICKNESS PER LATEST REVISION OF MIL-STD-1835.

2. CORNER PADS MAY HAVE A 45°X.020IN/0.51mm MAXIMUM CHAMFER TO ACCOMPLISH THE .015IN/0.38mm DIMENSION.

4. REFERENCE JEDEC REGISTRATION MS-004, VARIATION CB, DATED 7/90.

CONTROLLING DIMENSION IS INCH
VALUES IN [ ] ARE MILLIMETERS

MIL/AERO
CONFIGURATION CONTROL

APPROVALS	DATE
DRAWN: Dwayne Grady	02/10/94
DFTG. CHK.	
ENGR. CHK.	
APPROVAL	

PROJECTION

INCH [MM]

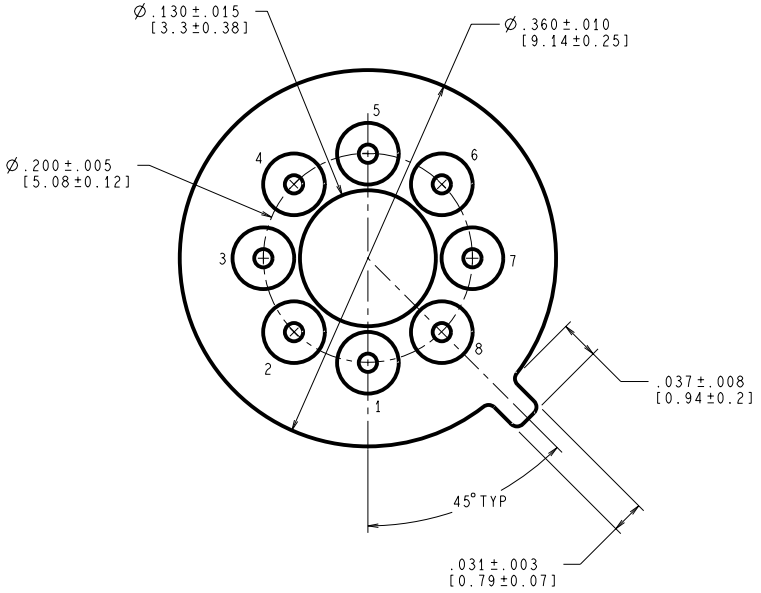
NATIONAL SEMICONDUCTOR CORPORATION
2900 Semiconductor Drive, Santa Clara, CA 95052-8090

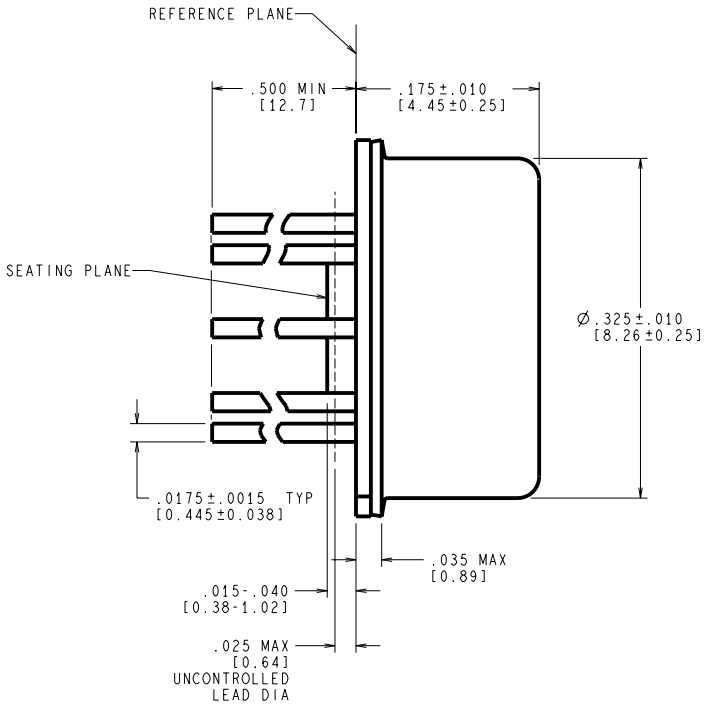
LEADLESS CHIP CARRIER, TYPE C, 20 TERMINAL

SCALE	SIZE	DRAWING NUMBER	REV
N/A	C	MKT-E20A	E

DO NOT SCALE DRAWING | SHEET 1 of 1

REVISIONS				
LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
F	REVISE & REDRAW PER CURRENT STANDARD; UPDATE MIL/AERO STAMP & TITLE.	11002	06/22/95	MS/





CONTROLLING DIMENSION IS INCH
VALUES IN [] ARE MILLIMETERS

MIL-I-38535
CONFIGURATION CONTROL

NOTES: UNLESS OTHERWISE SPECIFIED

1. LEADS TO BE LOCATED WITHIN .007 IN/ 0.18 mm OF THEIR TRUE POSITIONS RELATIVE TO A MAXIMUM WIDTH TAB.
2. STANDARD METAL CAN TYPE: SOLID BASE WITH CERAMIC STANDOFF.
3. APPLIES TO MIL-AERO AND LINEAR PRODUCTS.
4. REFERENCE JEDEC REGISTRATION TO-99, JEDEC PUBLICATION No.95.

APPROVALS	DATE
DRAWN: MARTA SUCHY	06/22/95
DFTG. CHK.	
ENGR. CHK.	

PROJECTION — INCH [MM]

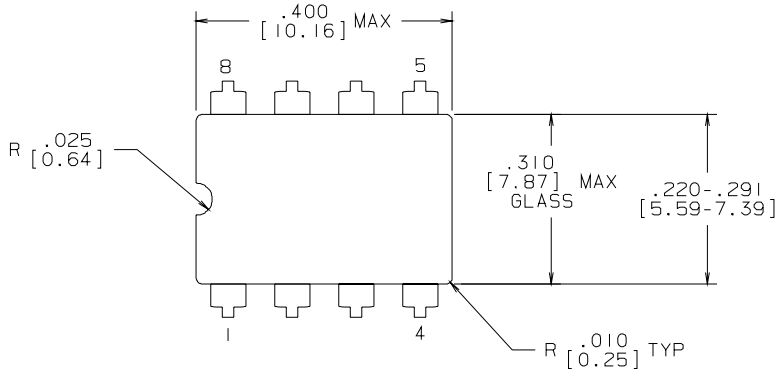
National Semiconductor
2900 Semiconductor dr, Santa Clara, CA 95052-8090

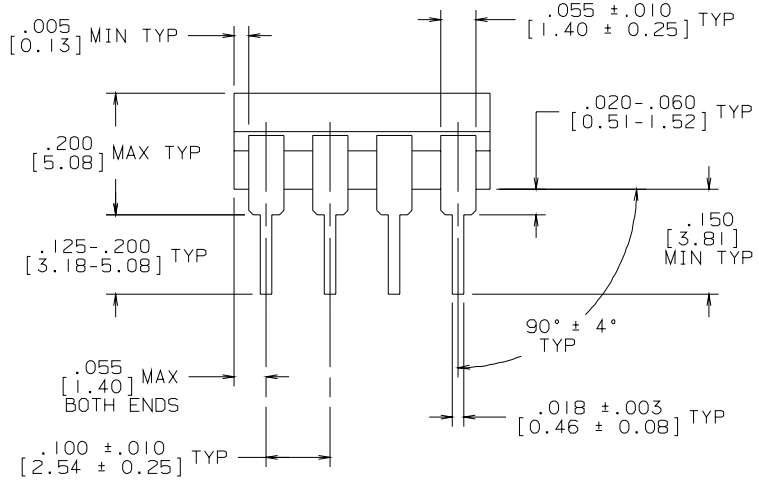
METAL CAN, TO-99, 8 LEAD, .200 DIA P.C.

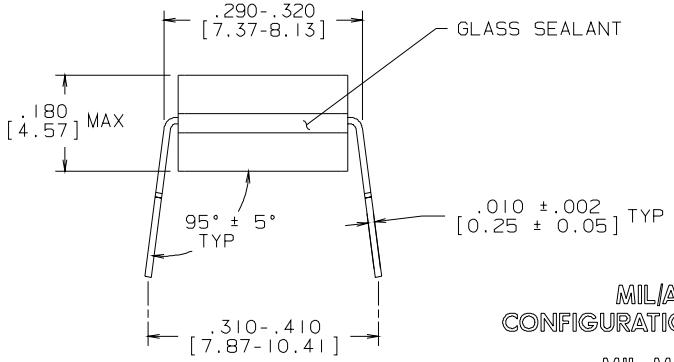
SCALE	SIZE	DRAWING NUMBER	REV
N/A	C	MKT-H08C	F

DO NOT SCALE DRAWING — SHEET 1 of 1

REVISIONS				
LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
L	REVISE PER CURRENT STD; REDRAW	10002	09/21/93	TL/







MIL/AERO
CONFIGURATION CONTROL

MIL-M-38510
CONFIGURATION CONTROL

NOTES: UNLESS OTHERWISE SPECIFIED

1. LEAD FINISH TO BE 200 MICROINCHES / 5.08 MICROMETERS MINIMUM SOLDER MEASURED AT THE CREST OF THE MAJOR FLATS.
2. JEDEC REGISTRATION MO-036, VARIATION AA, DATED 04/1981.

CONTROLLING DIMENSION: INCH

APPROVALS	DATE
DRAWN T. LEQUANG	09/21/93
DFTG. CHK.	
ENGR. CHK.	
APPROVAL	

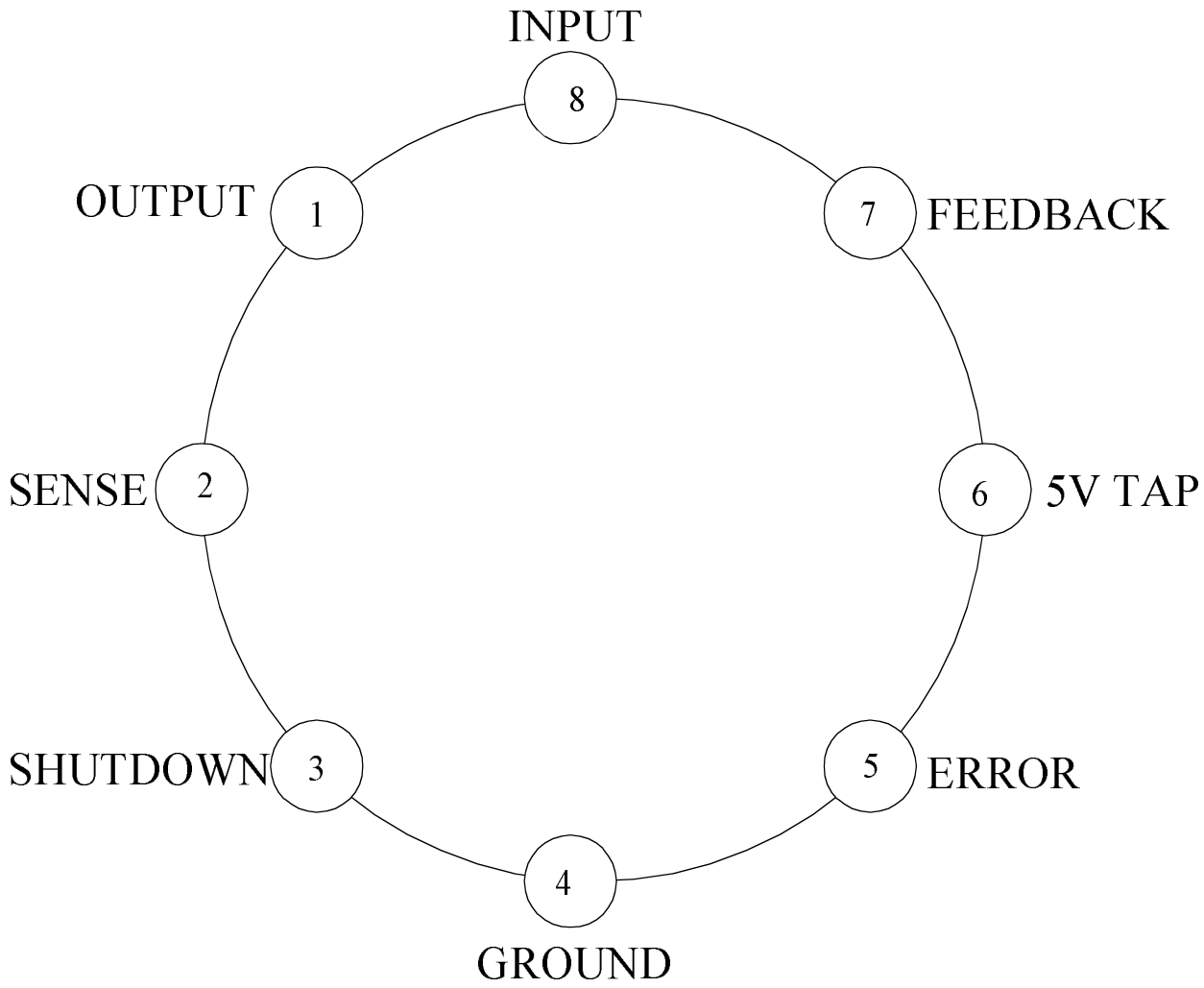
PROJECTION
INCH
[MM]

NATIONAL SEMICONDUCTOR CORPORATION
2900 Semiconductor Drive, Santa Clara, CA 95052-8090

CERDIP (J), 8 LEAD

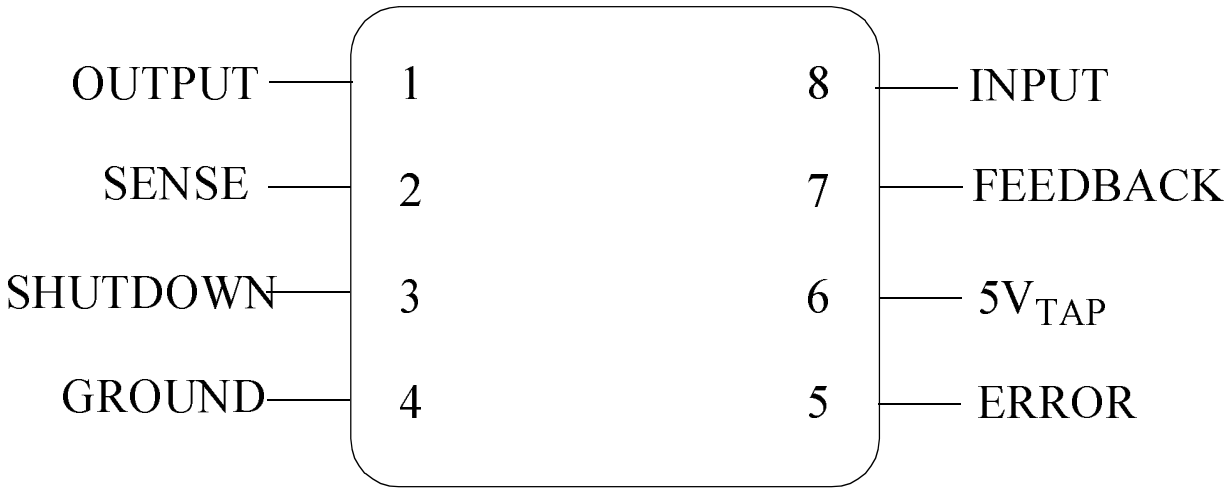
SCALE	SIZE	DRAWING NUMBER	REV
N/A	B	MKT-J08A	L

DO NOT SCALE DRAWING | SHEET 1 OF 1



LP2951H
8 - PIN METAL CAN
CONNECTION DIAGRAM
TOP VIEW
P000205A

National Semiconductor™
MIL/AEROSPACE OPERATIONS
2900 SEMICONDUCTOR DRIVE
SANTA CLARA, CA 95050



LP2951J

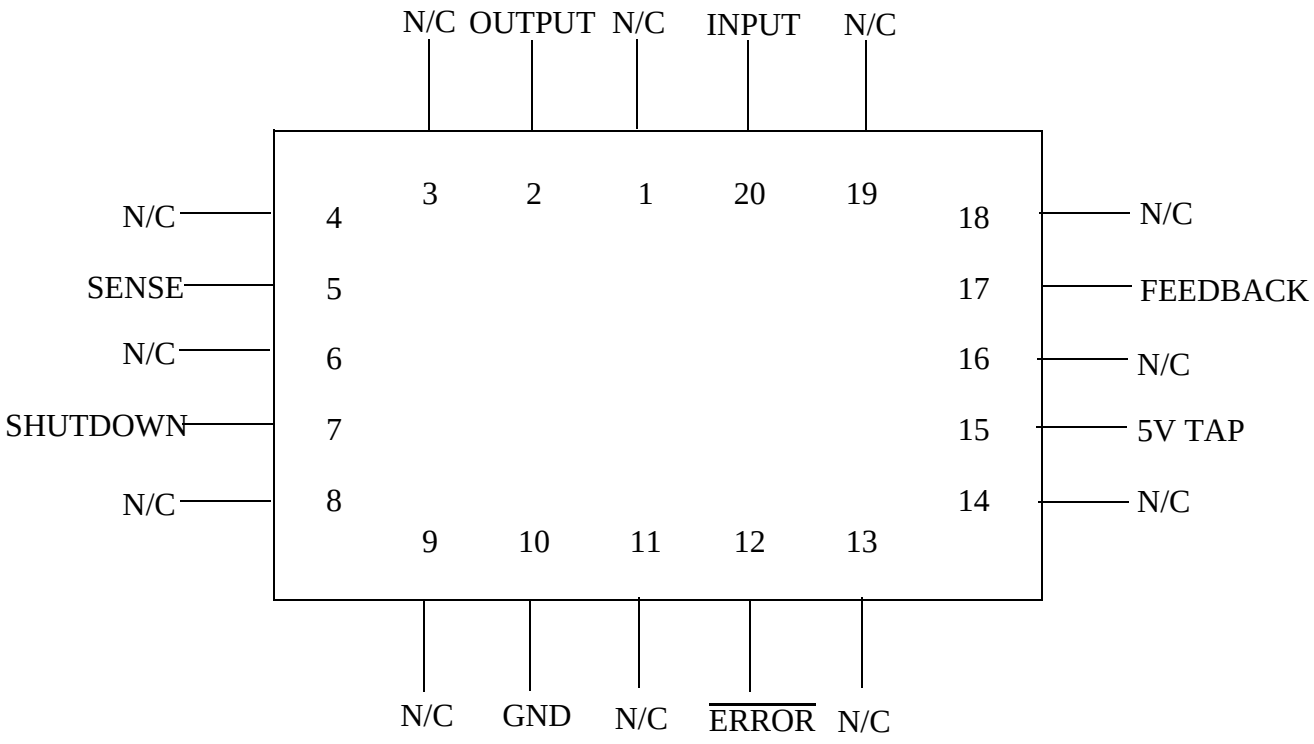
8 - LEAD DIP

CONNECTION DIAGRAM

TOP VIEW

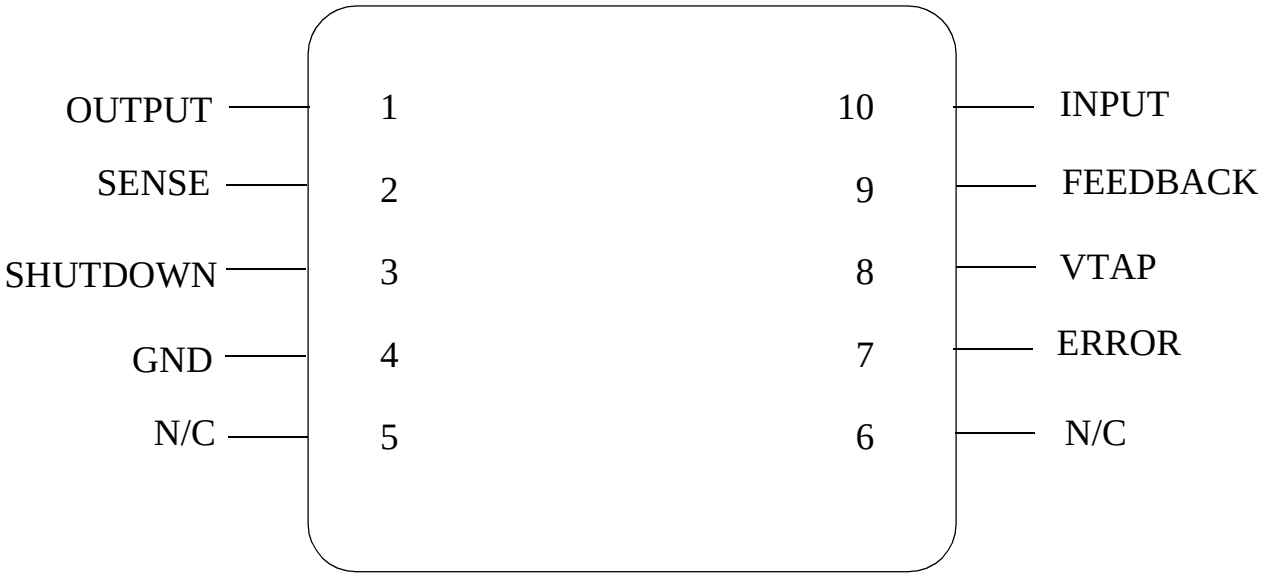
P000206A

National Semiconductor™
MIL/AEROSPACE OPERATIONS
2900 SEMICONDUCTOR DRIVE
SANTA CLARA, CA 95050



LP2951E
20 - LEAD LCC
CONNECTION DIAGRAM
TOP VIEW
P000251B

National Semiconductor™
MIL/AEROSPACE OPERATIONS
2900 SEMICONDUCTOR DRIVE
SANTA CLARA, CA 95050



LP2951WG

10 - LEAD CERAMIC SOIC

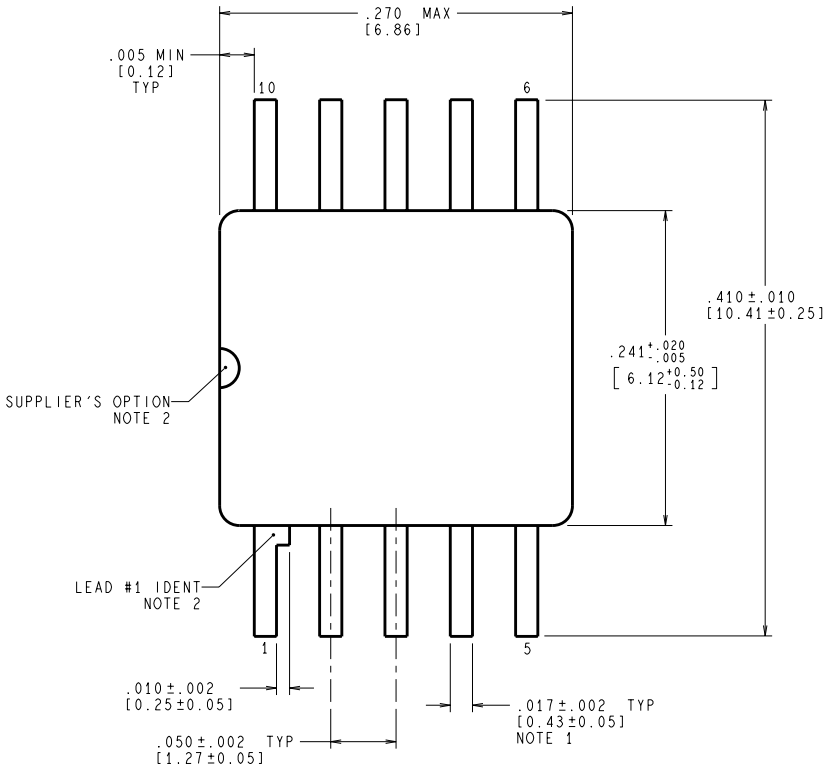
CONNECTION DIAGRAM

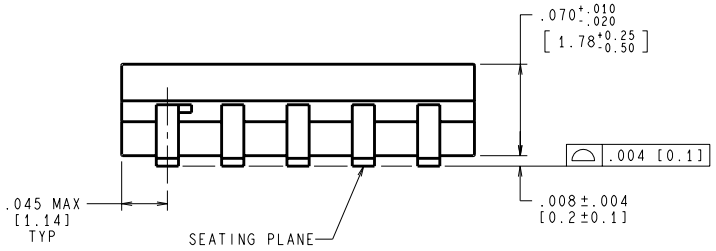
TOP VIEW

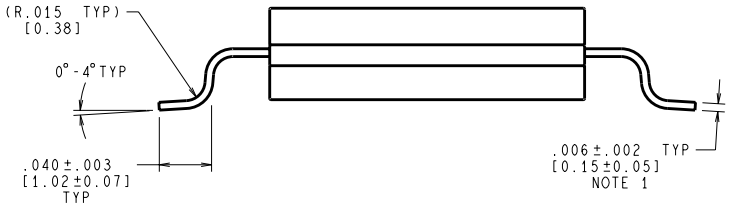
P000374A

National Semiconductor™
MIL/AEROSPACE OPERATIONS
2900 SEMICONDUCTOR DRIVE
SANTA CLARA, CA 95050

REVISIONS				
LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
A	RELEASE TO DOCUMENT CONTROL	11374	02/29/1996	MS/KH
B	LD PITCH TOL WAS ±.005; CHANGE LD RADIUS TO REF DIM; REMOVE THE OTHER R.006±.002 DIM .040±.003 WAS .037±.003	11441	04/19/1996	MS/KH
C	R .015[0.38] WAS R .006[0.15]	11838	10/08/1997	TL/







NOTES: UNLESS OTHERWISE SPECIFIED

1. LEAD FINISH: SOLDER DIPPED WITH Sn60 OR Sn63 SOLDER CONFORMING TO MIL-PRF-38535 TO A MINIMUM THICKNESS OF 200 MICROINCHES/ 5.08 MICROMETERS. SOLDER MAY BE APPLIED OVER LEAD BASIS METAL OR Sn PLATE. MAXIMUM LIMIT MAY BE INCREASED BY .003 IN/ 0.08mm AFTER LEAD FINISH APPLIED.
2. LEAD 1 IDENTIFICATION SHALL BE:
   a) A NOTCH OR OTHER MARK WITHIN THIS AREA
   b) A TAB ON LEAD 1, EITHER SIDE
3. NO JEDEC REGISTRATION AS OF FEBRUARY 1996.

CONTROLLING DIMENSION IS INCH
VALUES IN [ ] ARE MILLIMETERS

MIL-PRF-38535
CONFIGURATION CONTROL

APPROVALS	DATE
DRAWN: MARTA SUCHY	02/29/96
DFTG. CHK.	
ENGR. CHK.	

National Semiconductor
2900 Semiconductor dr, Santa Clara, CA 95052-8090

CERPACK, 10 LEAD, GULL WING

PROJECTION
INCH [MM]

SCALE	SIZE	DRAWING NUMBER	REV
N/A	C	(SC)MKT-WG10A	C

DO NOT SCALE DRAWING | SHEET 1 of 1

Revision History

Rev	ECN #	Rel Date	Originator	Changes
1B1	M0002864	05/19/98	Barbara Lopez	Update MDS: MNLP2951-X Rev. 1A0 to MNLP2951-X Rev. 1B1. Added WG package to SMD number and NSID. Updated power dissipation to reflect all packages. Updated thermal resistance to reflect all packages. Updated ESD rating. Updated Absolute junction temperature. Added graphics for all packages. Added Package Weights.

This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.

National Semiconductor was acquired by Texas Instruments.

http://www.ti.com/corp/docs/investor_relations/pr_09_23_2011_national_semiconductor.html

This file is the datasheet for the following electronic components:

LP2951ACMMX-3.0 - http://www.ti.com/product/lp2951acmmx-3.0?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951CMMX-3.3 - http://www.ti.com/product/lp2951cmmx-3.3?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACM-3.0 - http://www.ti.com/product/lp2951acm-3.0?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACSD-3.0 - http://www.ti.com/product/lp2951acsd-3.0?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951CMX - http://www.ti.com/product/lp2951cmx?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACM-3.3 - http://www.ti.com/product/lp2951acm-3.3?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACMM - http://www.ti.com/product/lp2951acmm?HQS=TI-null-null-dscatalog-df-pf-null-wwe

5962-3870501M2A - http://www.ti.com/product/5962-3870501m2a?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACMM-3.0 - http://www.ti.com/product/lp2951acmm-3.0?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACSD-3.3 - http://www.ti.com/product/lp2951acsd-3.3?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACMM-3.3 - http://www.ti.com/product/lp2951acmm-3.3?HQS=TI-null-null-dscatalog-df-pf-null-wwe

5962-3870501MGA - http://www.ti.com/product/5962-3870501mga?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACMMX - http://www.ti.com/product/lp2951acmmx?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951CMMX-3.0 - http://www.ti.com/product/lp2951cmmx-3.0?HQS=TI-null-null-dscatalog-df-pf-null-wwe

5962-3870501MPA - http://www.ti.com/product/5962-3870501mpa?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACMMX-3.3 - http://www.ti.com/product/lp2951acmmx-3.3?HQS=TI-null-null-dscatalog-df-pf-null-wwe

5962-3870501S2A - http://www.ti.com/product/5962-3870501s2a?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951CSDX-3.0 - http://www.ti.com/product/lp2951csdx-3.0?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951CSDX-3.3 - http://www.ti.com/product/lp2951csdx-3.3?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951CMX-3.0 - http://www.ti.com/product/lp2951cmx-3.0?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951CMX-3.3 - http://www.ti.com/product/lp2951cmx-3.3?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACSDX - http://www.ti.com/product/lp2951acsdx?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACSDX-3.0 - http://www.ti.com/product/lp2951acsdx-3.0?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACMX - http://www.ti.com/product/lp2951acmx?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACN-3.0 - http://www.ti.com/product/lp2951acn-3.0?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951CSD-3.3 - http://www.ti.com/product/lp2951csd-3.3?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACN - http://www.ti.com/product/lp2951acn?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951CSD-3.0 - http://www.ti.com/product/lp2951csd-3.0?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951CN - http://www.ti.com/product/lp2951cn?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACSDX-3.3 - http://www.ti.com/product/lp2951acsdx-3.3?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951C MDC - http://www.ti.com/product/lp2951c mdc?HQS=TI-null-null-dscatalog-df-pf-null-wwe

5962-3870501SPA - http://www.ti.com/product/5962-3870501spa?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACMX-3.0 - http://www.ti.com/product/lp2951acmx-3.0?HQS=TI-null-null-dscatalog-df-pf-null-wwe

5962-3870501MXA - http://www.ti.com/product/5962-3870501mxa?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951CN-3.0 - http://www.ti.com/product/lp2951cn-3.0?HQS=TI-null-null-dscatalog-df-pf-null-wwe

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LP2951CSD - http://www.ti.com/product/lp2951csd?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951CSDX - http://www.ti.com/product/lp2951csdx?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951C MWC - http://www.ti.com/product/lp2951c mwc?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACN-3.3 - http://www.ti.com/product/lp2951acn-3.3?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951CMMX - http://www.ti.com/product/lp2951cmmx?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACSD - http://www.ti.com/product/lp2951acsd?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951C-3.3 MDC - http://www.ti.com/product/lp2951c-3.3 mdc?HQS=TI-null-null-dscatalog-df-pf-null-wwe

5962-3870501BPA - http://www.ti.com/product/5962-3870501bpa?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACMX-3.3 - http://www.ti.com/product/lp2951acmx-3.3?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951C-3.3 MWC - http://www.ti.com/product/lp2951c-3.3 mwc?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951CM - http://www.ti.com/product/lp2951cm?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951CM-3.0 - http://www.ti.com/product/lp2951cm-3.0?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951ACM - http://www.ti.com/product/lp2951acm?HQS=TI-null-null-dscatalog-df-pf-null-wwe

LP2951CM-3.3 - http://www.ti.com/product/lp2951cm-3.3?HQS=TI-null-null-dscatalog-df-pf-null-wwe

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